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**AMENDMENT UNDER 37 CFR 1.116
EXPEDITED PROCEDURE -
EXAMINING GROUP 1762**

Box AF
Assistant Commissioner for Patents
Washington, D.C. 20231

PATENT
Attorney Docket No.: AM524R1/T289
TTC No.: 16301-028900

On June 13, 2000

TOWNSEND and TOWNSEND and CREW LLP

By: Linda Bolisch

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

KATSUYUKI MUSAKA et al.

Application No.: 09/187,551

Filed: November 5, 1998

For: METHOD FOR FORMING A THIN
FILM FOR A SEMICONDUCTOR
DEVICE

Examiner: Marianne Padgett

**AMENDMENT UNDER 37 CFR 1.116
EXPEDITED PROCEDURE EXAMINING
GROUP 1762**

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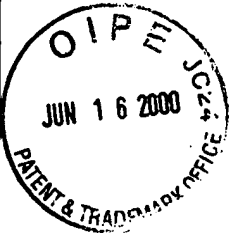
Sir:

In response to the Final Office Action mailed April 14, 2000, please amend this application as follows:

IN THE CLAIMS:

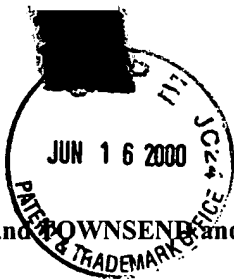
Please cancel claim ~~30~~ without prejudice and amend claims 27 and 32 as follows. Note that the remaining claims are unamended but are reproduced below for the Examiner's convenience and reference.

1. A method of forming a conformal thin film of silicon oxide on a substrate having spaced conductive lines thereon comprising the steps of:
mounting a substrate onto a substrate support in a vacuum chamber;



Do Not enter after 4/17/00

5-11-00
A1



AF/RDU1762

AMENDMENT TRANSMITTAL

Corres. and Mail

TOWNSEND and TOWNSEND and CREW LLP
(650) 326-4200

BOX AF

Attorney Docket No. AM524R1/T289
TTC Ref No. 16301-028900US

In re application of: KATSUYUKI MUSAKA et al.

Application No.: 09/187,551

Filed: November 5, 1998

Group Art Unit: 1762

For: METHOD FOR FORMING A THIN FILM
FOR A SEMICONDUCTOR DEVICE

Date: June 13, 2000

I hereby certify that this is being deposited with the United States
Postal Service as first class mail in an envelope addressed to:

Assistant Commissioner for Patents
Box AF
Washington, D.C. 20231

Signed: Synda Polisch

THE ASSISTANT COMMISSIONER FOR PATENTS
Washington, D.C. 20231

Sir:

Transmitted herewith is an Amendment Under 37 CFR 1/116 in the above-identified application. Also enclosed are two return receipt
postcards.

If any extension of time is needed, then this response should be considered a petition therefor.

The filing fee has been calculated as shown below:

	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NO. PREVIOUSLY PAID FOR	PRESENT EXTRA
TOTAL	* 17	MINUS	** 20	= 0
INDEP.	* 3	MINUS	*** 3	= 0
[] FIRST PRESENTATION OF MULTIPLE DEP. CLAIM				

SMALL ENTITY

RATE	ADDIT. FEE
x \$9.00 =	
x \$39.00 =	
+ \$130.00 =	
TOTAL	

OTHER THAN
SMALL ENTITY

RATE	ADDIT. FEE
x \$18.00 =	\$0.00
x \$78.00 =	\$0.00
+ \$260.00 =	
TOTAL	\$0.00

[X] No fee is due.

Please charge Deposit Account No. 20-1430 as follows:

[X] Any additional fees associated with this paper or during the pendency of this application.

NO extra copies of this sheet are enclosed.

TOWNSEND and TOWNSEND and CREW LLP

Chun-Pok Leung
Reg. No. 41,405
Attorneys for Applicants

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